















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	IRFB5615
Overseas Part Number	IRFB5615
▶ Equivalent Part Number	IRFB5615





General Description

- Advanced Trench MOS Technology
- Low Gate Charge
- Low Rds(ON)
- 100% EAS Guaranteed
- Green Device Available

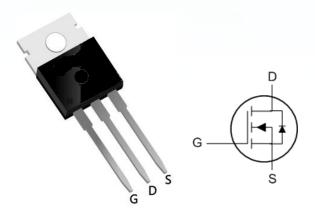
Applications

- Load Switch
- LED Applications
- Networking Applications
- Quick Charger

Product Summary

BVDSS	RDSON	ID
150V	13mΩ	85A

TO220 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	150	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	85	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	54	А
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	9.6	А
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	7.7	А
I _{DM}	Pulsed Drain Current ²	180	А
EAS	Single Pulse Avalanche Energy ³	420	mJ
las	Avalanche Current	41	А
P _D @T _C =25°C	Total Power Dissipation ⁴	178	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹		55	°C/W
R _{0JC}	Thermal Resistance Junction-Case ¹		0.7	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	150			V
D	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =20A		9.8	13	mΩ
R _{DS(ON)}		V _{GS} =4.5V , I _D =20A		11	15	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2	1.7	2.5	V
la co	Drain-Source Leakage Current	V _{DS} =120V , V _{GS} =0V , T _J =25°C			1	- uA
IDSS		V _{DS} =120V , V _{GS} =0V , T _J =55°C			5	
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5		Ω
Qg	Total Gate Charge			37		
Q_gs	Gate-Source Charge	V _{DS} =75V , V _{GS} =4.5V , I _D =20A		12.3		nC
Q_{gd}	Gate-Drain Charge			17.7		
T _{d(on)}	Turn-On Delay Time			12		
Tr	Rise Time	V_{DD} =75V , V_{GS} =10V , R_{G} =6 Ω ,		18		
T _{d(off)}	Turn-Off Delay Time	I _D =1A		88		ns
T _f	Fall Time			142		
Ciss	Input Capacitance	V _{DS} =75V , V _{GS} =0V , f=1MHz		4137		
Coss	Output Capacitance			290		рF
C _{rss}	Reverse Transfer Capacitance			22		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,5,6}	V _G =V _D =0V , Force Current			85	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V
t _{rr}	Reverse Recovery Time	Ir=20A , di/dt=100A/μs ,		76		nS
Qrr	Reverse Recovery Charge	T _J =25°C		252		nC

Note

- 1. The data tested by surface mounted on a 1 inch $^2\,\text{FR-4}$ board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=0.5mH, I_{AS} =41A
- 4. The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

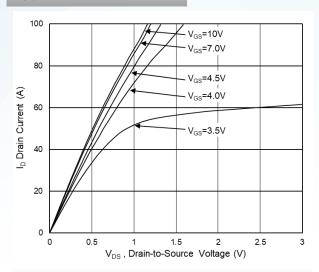


Fig.1 Typical Output Characteristics

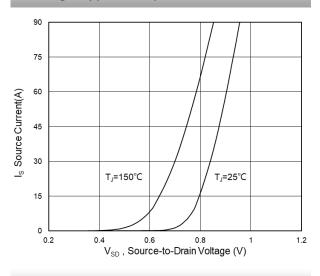


Fig.3 Source Drain Forward Characteristics

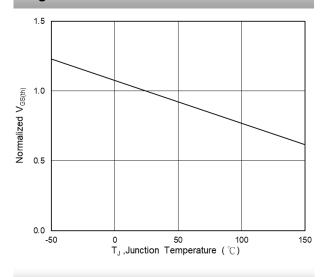


Fig.5 Normalized $V_{\text{GS(th)}}$ vs T_{J}

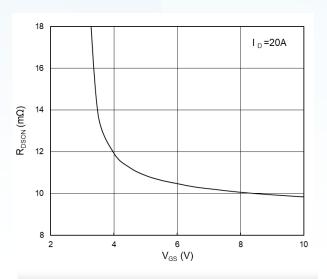


Fig.2 On-Resistance vs G-S Voltage

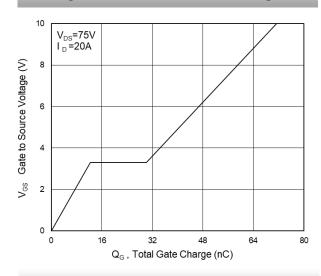


Fig.4 Gate-Charge Characteristics

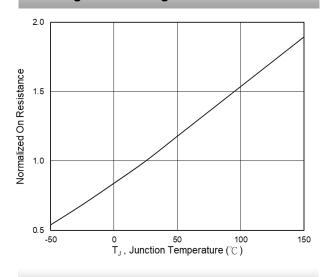
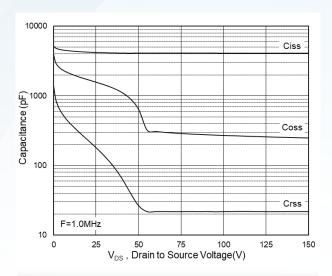


Fig.6 Normalized R_{DSON} vs T_J





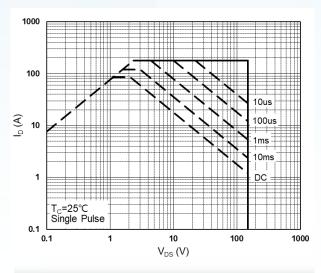


Fig.7 Capacitance

Fig.8 Safe Operating Area

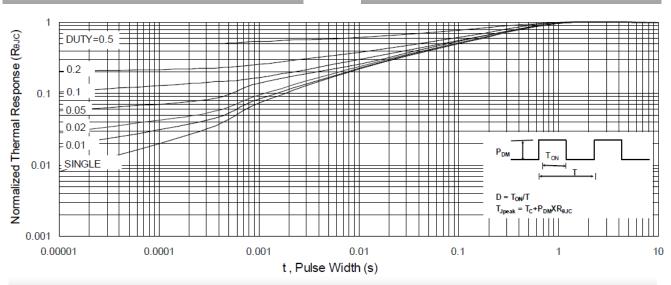
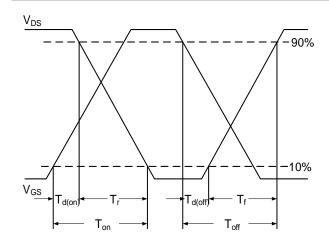


Fig.9 Normalized Maximum Transient Thermal Impedance



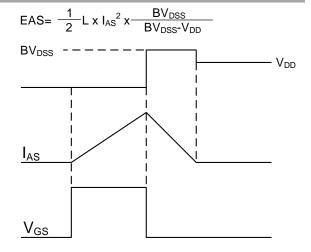


Fig.10 Switching Time Waveform

Fig.11 Unclamped Inductive Waveform



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